COG with KONNEKT™ Technology, 50 - 3,000 VDC (Commercial & Automotive Grade)











Overview

KEMET's COG with KONNEKTTM technology surface mount capacitors are designed for high-efficiency and high-density power applications. KONNEKT high density packaging technology uses an innovative Transient Liquid Phase Sintering (TLPS) material to create a surface mount multichip solution for high density packaging. By utilizing KEMET's robust and proprietary COG base metal electrode (BME) dielectric system, these capacitors are well suited for power converters, inverters, snubbers, and resonators where high efficiency is a primary concern.

With an operating temperature range up to 125°C, these capacitors can be mounted close to fast switching semiconductors in high power density applications, which require minimal cooling. COG with KONNEKT technology also exhibits high mechanical robustness compared to other dielectric technologies, allowing the capacitor to be mounted without the use of metal frames.

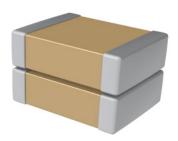
COG with KONNEKT series compliments the KC-LINK with KONNEKT series by offering a wider voltage range and operating temperature range up to 125°C

Benefits

- Extremely high-power density and ripple current capability
- Extremely low equivalent series resistance (ESR)
- Extremely low equivalent series inductance (ESL)
- Capacitance offerings ranging from 0.78 nF 940 nF
- DC voltage ratings from 50 3,000 V
- EIA sizes 1812 and 2220
- Operating temperature range of -55°C to +125°C
- · No capacitance shift with voltage
- No piezoelectric noise
- · High thermal stability
- Surface mountable using standard MLCC reflow profiles

Applications

- Wide bandgap (WBG), silicon carbide (SiC) and gallium nitride (GaN) systems
- · Data centers
- EV/HEV (drive systems, charging)
- LLC resonant converters
- Switched tank converters
- · Wireless charging systems
- · Photovoltaic systems
- · Power converters
- Inverters
- DC link
- Snubber





Ordering Information

С	1812	C	943	K	С	G	L	С	XXXX
Ceramic	Case Size (L"x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (V)	Dielectric	Subclass Designation	Termination Finish	Orientation and Packaging (Suffix/C-Spec)
С	1812 2220	C = Standard	Two single digits + number of zeros.	K = ±10%	5 = 50 V 1 = 100 V 2 = 200 V A = 250 V C = 500 V B = 630 V D = 1,000 V F = 1,500 V G = 2,000 V Z = 2,500 V H = 3,000 V	G = COG	L = KONNEKT	C = 100% matte Sn	See "Packaging and Orientation C-Spec Ordering Options Table"

Additional termination finish options may be available. Contact KEMET for details.

Orientation and Packaging (Suffix/C-Spec) Options Table

Mounting Orientation ¹	Tape and Reel Illustration	Packaging Type	Packaging/Grade Ordering Code (C-Spec)						
	Commercial Grade								
Standard		7" Reel/Unmarked	ΤU						
	0	13" Reel/Unmarked	7210						
	Automoti	ve Grade							
Standard		7" Reel/Unmarked	AUTO						
		13" Reel/Unmarked	AUT07210						

¹ Orientation refers to the positioning of the KONNEKT capacitors in the Tape and Reel pockets. This allows pick and place machines to place capacitors on the PCB in the correct orientation.



Automotive C-Spec Information

KEMET automotive grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. These products are supported by a Product Change Notification (PCN) and Production Part Approval Process warrant (PPAP).

Automotive products offered through our distribution channel have been assigned an inclusive ordering code C-Spec, "AUTO." This C-Spec was developed in order to better serve small and medium-sized companies that prefer an automotive grade component without the requirement to submit a customer Source Controlled Drawing (SCD) or specification for review by a KEMET engineering specialist. This C-Spec is therefore not intended for use by KEMET OEM automotive customers and are not granted the same "privileges" as other automotive C-Specs. Customer PCN approval and PPAP request levels are limited (see details below.)

Product Change Notification (PCN)

The KEMET product change notification system is used to communicate primarily the following types of changes:

- Product/process changes that affect product form, fit, function, and/or reliability
- · Changes in manufacturing site
- Product obsolescence

KEMET Automotive	Customer Notifica	tion Due To:	Days Prior To	
C-Spec	Process/Product change	Obsolescence*	Implementation	
KEMET assigned ¹	Yes (with approval and sign off)	Yes	180 days minimum	
AUT0	Yes (without approval)	Yes	90 days minimum	

¹ KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

Production Part Approval Process (PPAP)

The purpose of the Production Part Approval Process is:

- To ensure that supplier can meet the manufacturability and quality requirements for the purchased parts.
- To provide the evidence that all customer engineering design records and specification requirements are properly understood and fulfilled by the manufacturing organization.
- To demonstrate that the established manufacturing process has the potential to produce the part.

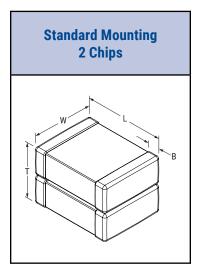
KEMET Automotive	1	PPAP (Product Part Approval Process) Level								
C-Spec	1	2	3	4	5					
KEMET assigned ¹	•	•	•	•	•					
AUTO			0							

¹ KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

- Part number specific PPAP available
- Product family PPAP only



Dimensions - Millimeters (Inches)



EIA SIZE CODE	METRIC SIZE CODE	Number of Chips	Mounting	L LENGTH	W WIDTH	T THICKNESS	B BANDWIDTH	Mounting Technique	Typical Average Piece Weight (g)
1812	4532	2	Standard	4.50 (0.177) ±0.30 (0.012)	3.20 (0.126) ±0.30 (0.012)	See Table 1A and 1B for	0.60 (0.024)	Solder Reflow	See Table 1A
2220	5750	2	Standard	5.70 (0.224) ±0.40 (0.016)	5.00 (0.197) ±0.40 (0.016	Thickness	±0.35 (0.014)	Only	and 1B for Weights



Table 1A - 1812 Product Ordering Codes, Ratings, and Package Quantities

				Number		Typical	Tape & Rec	el Quantity
KEMET Part Number ¹	EMET Part Canacitance Cap Voltage of Thickness			Average Piece Weight (g)	7" Tape & Reel	13" Tape & Reel		
C1812(a)444(b)5GLC(c)	440 nF	444	50 V		3.3 (0.130) ±0.4 (0.016)	0.19	500	2,000
C1812(a)304(b)1GLC(c)	300 nF	304	100 V		3.5 (0.138) ±0.4 (0.016)	0.19	500	2,000
C1812(a)204(b)2GLC(c)	200 nF	204	200 V		4.1 (0.161) ±0.4 (0.016)	0.24	275	1,050
C1812(a)204(b)AGLC(c)	200 nF	204	250 V		4.1 (0.161) ±0.4 (0.016)	0.24	275	1,050
C1812(a)943(b)CGLC(c)	94 nF	943	500 V		5.1 (0.200) ±0.4 (0.016)	0.30	200	850
C1812(a)943(b)BGLC(c)	94 nF	943	630 V	2	5.1 (0.200) ±0.4 (0.016)	0.30	200	850
C1812(a)303(b)DGLC(c)	30 nF	303	1,000 V		5.1 (0.200) ±0.4 (0.016)	0.30	200	850
C1812(a)542(b)FGLC(c)	5.4 nF	542	1,500 V		5.1 (0.200) ±0.4 (0.016)	0.30	200	850
C1812(a)302(b)GGLC(c)	3 nF	302	2,000 V		5.1 (0.200) ±0.4 (0.016)	0.30	200	850
C1812(a)142(b)ZGLC(c)	1.4 nF	142	2,500 V		5.1 (0.200) ±0.4 (0.016)	0.30	200	850
C1812(a)781b)HGLC(c)	0.78 nF	781	3,000 V		5.1 (0.200) ±0.4 (0.016)	0.30	200	850

¹ Complete part number requires additional characters in the numbered positions provided in order to indicate capacitance tolerance and grade. For each numbered position, available options are as follows:

⁽a) End Termination "C".

⁽b) Capacitance tolerance character "K".

⁽c) C-Spec for Product Grade, Reeling and Mounting Orientation.



Table 1B - 2220 Product Ordering Codes, Ratings, and Package Quantities

				Number		Typical	Tape & Red	el Quantity
KEMET Part Number ¹	Capacitance	Cap Code	Voltage	of Chips	Thickness mm (inch)	Average Piece Weight (g)	7" Tape & Reel	13" Tape & Reel
C2220(a)944(b)5GLC(c)	940 nF	944	50 V		3.5 (0.138) ±0.4 (0.016)	0.45	475	1825
C2220(a)664(b)1GLC(c)	660 nF	664	100 V		3.5 (0.138) ±0.4 (0.016)	0.45	475	1825
C2220(a)444(b)2GLC(c)	440 nF	444	200 V		4.1 (0.161) ±0.4 (0.016)	0.45	225	950
C2220(a)204(b)CGLC(c)	200 nF	204	500 V	500 V		0.65	300	1,250
C2220(a)204(b)BGLC(c)	200 nF	204	630 V	2	5.1 (0.200) ±0.4 (0.016)	0.65	300	1,250
C2220(a)663(b)DGLC(c)	66 nF	663	1,000 V	2	5.1 (0.200) ±0.4 (0.016)	0.65	300	1,250
C2220(a)143(b)FGLC(c)	14 nF	143	1,500 V		5.1 (0.200) ±0.4 (0.016)	0.65	300	1,250
C2220(a)782(b)GGLC(c)	7.8 nF	782	2,000 V		5.1 (0.200) ±0.4 (0.016)	0.65	300	1,250
C2220(a)362(b)ZGLC(c)	3.6 nF	362	2,500 V		5.1 (0.200) ±0.4 (0.016)	0.65	300	1,250
C2220(a)202(b)HGLC(c)	2 nF	202	3,000 V		5.1 (0.200) ±0.4 (0.016)	0.65	300	1,250

¹ Complete part number requires additional characters in the numbered positions provided in order to indicate capacitance tolerance and grade. For each numbered position, available options are as follows:

⁽a) End Termination "C".

⁽b) Capacitance tolerance character "K".

⁽c) C-Spec for Product Grade, Reeling and Mounting Orientation.



Table 2 - Performance and Reliability: Test Methods and Conditions (Commercial Only)

Test	Reference		Tes	st Co	ondition		Limits
Visual and Mechanical	KEMET Internal	No	defects that m	ay af	fect performance (1	10X)	Dimensions according KEMET Spec Sheet
Capacitance (Cap)	KEMET Internal	1 kHz ±50 Hz and 1.0 ±0.2 V _{rms} of capacitance Capacitance measurements (including tolerance) are indexed to a referee time of 1,000 hours				ance)	Within Tolerance
Dissipation Factor (DF)	KEMET Internal		1 kHz ±50	Hz a	and 1.0 ±0.2 V _{rms}		Dissipation factor (DF) maximum limit at 25°C = 0.1%
Insulation Resistance (IR)	KEMET Internal		l voltage appli Fo	ed fo	00 VDC: r 120 ±5 seconds at 00 VDC: 0 ±5 seconds at 25°		Within Specification To obtain IR limit, divide MΩ-μF value by the capacitance and compare to GΩ limit. Select the lower of the two limits. 1,000 ΜΩ-μF or 100 GΩ
Temperature Coefficient of Capacitance (TCC)	KEMET Internal		pacitance cha and	rency: 1 kHz ±50 Hz range with reference to +25°C d 0 VDC applied specification sheet for voltage Temperature (°C) +25°C -55°C +25°C (Reference Temperature) +125°C			±30 PPM/°C
Dielectric Withstanding Voltage (DWV)	KEMET Internal	(5 ±1 s	Rated DC Voltage < 500 500 630 ≥ 1,000 seconds and charge, 50 n			eeding	Cap: Initial Limit DF: Initial Limit IR: Initial Limit Withstand test voltage without insulation breakdown or damage.
Aging Rate (Maximum % Capacitance Loss/Decade Hour)	KEMET Internal	50 mA) Maximum % capacitance loss/decade hour					0% Loss/Decade Hour



Table 2 - Performance and Reliability: Test Methods and Conditions (Commercial Only) cont.

Test	Reference	Test Condition	Limits
Terminal Strength	KEMET Internal	Shear stress test per specific case size, Time: 60±1 seconds Case Size Force 1812 2220 18N	No evidence of mechanical damage
Board Flex	AEC-Q200-005	Standard Termination System 3.0 mm Test time: 60± 5 seconds Ramp time: 1 mm/second (Unit:mm)	No evidence of mechanical damage
Solderability	J-STD-002	Magnification 10X. Conditions: Category 2 (Dry Bake 155°C/4 hours ±15 minutes) a) Method B, 245°C, SnPb b) Method B1 at 245°C, Pb-Free c) Method D, at 260°C, SnPb or Pb-Free	Visual Inspection. 95% coverage on termination. No leaching
Temperature Cycling	JESD22 Method JA-104	1,000 cycles (-55°C to +125°C) 2 - 3 cycles per hour Soak Time 1 or 5 minutes	Measurement at 24 hours ±4 hours after test conclusion. Cap: Initial Limit DF: Initial Limit IR: Initial Limit
Biased Humidity	MIL-STD-202 Method 103	Load Humidity: 1,000 hours 85°C/85% RH and 200 VDC. Add 100 KΩ resistor. Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 KΩ resistor.	Measurement at 24 hours ±4 hours after test conclusion. Within Post Environmental Limits Cap: ±0.3% or ±0.25 pF shift IR: 10% of Initial Limit DF Limits Maximum: 0.5%
Moisture Resistance	MIL-STD-202 Method 106	Number of cycles required 10, 24 hours per cycle. Steps 7a and 7b not required.	Measurement at 24 hours ±4 hours after test conclusion. Within Post Environmental Limits Cap: ±0.3% or ±0.25 pF shift IR: 10% of Initial Limit DF Limits Maximum: 0.5%



Table 2 - Performance and Reliability: Test Methods and Conditions (Commercial Only) cont.

Test	Reference	Test Condition	Limits
Thermal Shock	MIL-STD-202 Method 107	Number of cycles required 5, (-55°C to 125°C) Dwell time 15 minutes.	Cap: Initial Limit DF: Initial Limit IR: Initial Limit
High Temperature Life	1,000 hours at 125°C with 1.0 X rated voltage applied MIL-STD-202		Measurement at 24 hours ±4 hours after test conclusion. Within Post Environmental Limits
Storage Life	Method 108	1,000 hours at 125°C, Unpowered	Cap: ±0.3% or ±0.25 pF shift IR: 10% of Initial Limit DF Limits Maximum: 0.5%
Vibration	MIL-STD-202 Method 204	5 g's for 20 minutes, 12 cycles each of 3 orientations. Test from 10 – 2,000 Hz	Cap: Initial Limit DF: Initial Limit IR: Initial Limit
Mechanical Shock	MIL-STD-202 Method 213	1,500 g's 0.5 ms Half-sine, Velocity Change 15.4 feet/second (Condition F)	Cap: Initial Limit DF: Initial Limit IR: Initial Limit
Resistance to MIL-STD-202 Solvents Method 215		Add Aqueous wash chemical OKEMCLEAN (A 6% concentrated Oakite cleaner) or equivalent. Do not use banned solvents.	Visual Inspection 10X Readable marking, no decoloration or stains. No physical damage.

Environmental Compliance





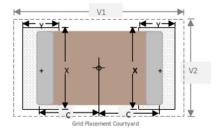


Lead (Pb)-free, RoHS, and REACH compliant without exemptions.



Table 3 - KONNEKT Land Pattern Design Recommendations per IPC-7351 (mm)

Chip Number	Mounting	EIA SIZE METRIC CODE SIZE CODE		Median (Nominal) Land Protrusion					
				С	Y	X	V1	V2	
2	Standard	1812	4532	2.05	1.40	3.50	6.00	4.00	
2	Standard	2220	5750	2.65	1.50	5.40	7.30	5.90	



Storage & Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature – reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. In addition, temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years upon receipt.

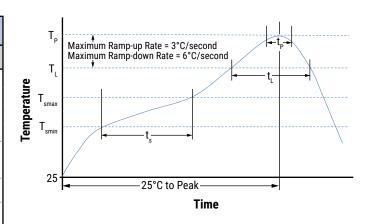


Soldering Process

Recommended Reflow Soldering Profile

KEMET's KONNEKT family of high density surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with convection and IR reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Termination Finish
Trome readure	100% matte Sn
Preheat/Soak	
Temperature Minimum (T _{smin})	150°C
Temperature Maximum (T _{Smax})	200°C
Time (t_s) from T_{Smin} to T_{Smax}	60 - 120 seconds
Ramp-Up Rate (T _L to T _p)	3°C/second maximum
Liquidous Temperature (T _L)	217°C
Time Above Liquidous (t _L)	60 - 150 seconds
Peak Temperature (T _P)	260°C
Time Within 5°C of Maximum Peak Temperature (t _p)	30 seconds maximum
Ramp-Down Rate (T _P to T _L)	6°C/second maximum
Time 25°C to Peak Temperature	8 minutes maximum



Note: All temperatures refer to the center of the package, measured on the capacitor body surface that is facing up during assembly reflow.

Hand Soldering and Removal of KONNEKT Capacitors

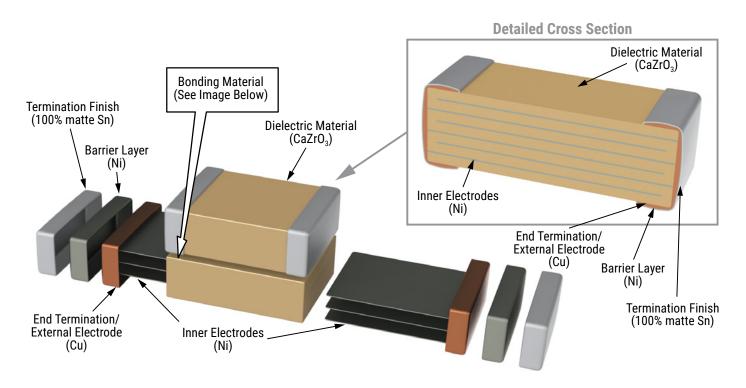
The preferred method of attachment for KEMET's KONNEKT Capacitors is IR or convection reflow where temperature, time and air flow are well controlled.

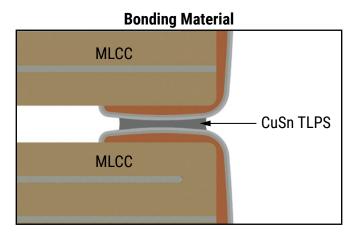
However, it is understood that the manual attachment of KONNEKT capacitors is necessary for prototype and lab testing. In these instances, care must be taken not to introduce excessive temperature gradients in the KONNEKT part type that may lead to cracking in the ceramic or separation of the TLPS material.

Please see KEMET's KONNEKT Soldering Guidelines here.



Construction – Standard Termination







Tape & Reel Packaging Information

KEMET offers X7R with KONNEKT technology capacitors packaged in 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems.

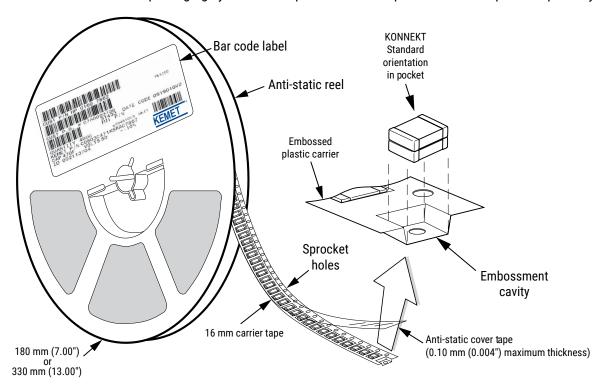


Table 4 - Carrier Tape Configuration, Embossed Plastic (mm)

			- 0:	Embossed Plastic		
EIA Case Size	Number of Chips	Chip Thickness	Tape Size (W) ¹	7" Reel	13" Reel	
			(**)	Pitch (P ₁) ²		
KONNEKT 1812	2	≤ 3.5 mm	16	8	8	
		> 3.5 mm	16	12	12	
KONNEKT 2220	2	2	≤ 3.5 mm >5.0 mm & ≤ 5.3 mm	16	8	8
		> 3.5 mm ≤ 5.0	16	12	12	

^{1.} Refer to Figures 1 and 2 for W and P_1 carrier tape reference locations.

^{2.} Refer to Tables 4 and 5 for tolerance specifications.



Figure 1 - Embossed (Plastic) Carrier Tape Dimensions

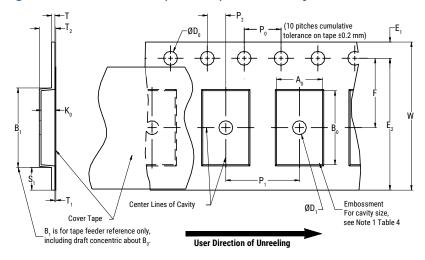


Table 5 - Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D _o	D ₁ Minimum Note 1	E ₁	P_0	P ₂	R Reference Note 2	S ₁ Minimum Note 3	T Maximum	T ₁ Maximum
16 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.5 (0.059)	1.75±0.10 (0.069±0.004)	4.0±0.10 (0.157±0.004)	2.0±0.05 (0.079±0.002)	30 (1.181)	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)

	Variable Dimensions — Millimeters (Inches)									
Case Size	Number of Chips	Tape Size	Pitch	B ₁ Maximum Note 4	${\rm E_2} \\ {\rm Minimum}$	F	P ₁	T ₂ Maximum	W Maximum	A ₀ ,B ₀ & K ₀
1812	2	16 mm	Triple (12mm) Double (8mm)	7.9 (0.311) 7.5 (0.295)	14.25 (0.561)	7.5±0.05 (0.138±0.002)	12.0±0.10 (0.472±0.004) 8.0±0.10 (0.315±0.004)	6.5 (0.256)	16.3 (0.642)	Note 5
2220	2	16 mm	Triple (12mm) Double (8mm)	8.5 (0.335) 9.2 (0.363)	14.25 (0.561)	7.5±0.05 (0.138±0.002)	12.0±0.10 (0.472±0.004) 8.0±0.10 (0.315±0.004)	6.5 (0.256)	16.3 (0.642)	Note 5

^{1.} The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.

- 2. The tape with or without components shall pass around R without damage (see Figure 6).
- 3. If S. < 1.0 mm, there may not be enough area for cover tape to be properly applied. See EIA Document 481, Paragraph 4.3 (b).
- 4. B, dimension is a reference dimension for tape feeder clearance only.
- 5. The cavity defined by A_{α} , B_{α} and K_{α} shall surround the component with sufficient clearance that:
- (a) the component does not protrude above the top surface of the carrier tape.
- (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
- (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3).
- (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 mm and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4).
- (e) For KPS product, A_a and B_a are measured on a plane 0.3 mm above the bottom of the pocket.
- (f) see Addendum in EIA Document 481 for standards relating to more precise taping requirements.



Packaging Information Performance Notes

- 1. Cover Tape Break Force: 1.0 kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength		
16 mm	0.1 to 1.3 newton (10 to 130 gf)		

Table 6 - Reel Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)						
Tape Size	A	B Minimum	С	D Minimum			
16 mm	178±0.20 (7.008±0.008) or 330±0.20 (13.000±0.008)	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)			
	Variable Dimensions — Millimeters (Inches)						
Tape Size	N Minimum See Note 2, Tables 2-3	W ₁	W ₂ Maximum	W ₃			
16 mm	50 (1.969)	16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)	Shall accommodate tape width without interference			



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Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.

Mouser Electronics

Authorized Distributor

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KEMET:

C1812C204K2GLCAUTO	C1812C204KAGLCAUTO	C1812C303KDGLCAUTC	C1812C304K1GLCAUTO
C1812C444K5GLCAUTO	C1812C943KBGLCAUTO	C1812C943KCGLCAUTO	C2220C143KFGLCAUTO
C2220C204KBGLCAUTO	C2220C204KCGLCAUTO	C2220C444K2GLCAUTO	C2220C663KDGLCAUTO
C2220C664K1GLCAUTO	C2220C944K5GLCAUTO	C1812C142KZGLCAUTO	C1812C542KFGLCAUTO
C1812C781KHGLCAUTO	C2220C782KGGLCAUTO	C1812C302KGGLCAUTO	C2220C202KHGLCAUTO
C2220C362KZGLCAUTO			